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Schematic diagram

NCE75H21D

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Marking and pin assignment

TO-263-2L top view

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(1) GO

NCE75H21D

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE75H21D uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in Automotive applications and a wide variety of other applications.

General Features

V_{DSS} =75V,I_D =210A
R_{DS(ON)} < 4mΩ @ V_{GS}=10V

- Good stability and uniformity with high E_{AS}
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Application

- Automotive applications
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE75H21D	NCE75H21D	TO-263-2L	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vdss	75	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	210	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	150	А
Pulsed Drain Current	I _{DM}	840	А
Maximum Power Dissipation	PD	330	W
Derating factor		2.2	W/°C
Single pulse avalanche energy (Note 4)	E _{AS}	2200	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C





Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 1)	R _{eJC} 0.455	°C/W
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Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Symbol Condition		Тур	Max	Unit
Off Characteristics				•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA				V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =75V,V _{GS} =0V			1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V			±200	nA
On Characteristics				•		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A		3	4	mΩ
Forward Transconductance	g fs	V _{DS} =25V,I _D =40A	100	165		S
Dynamic Characteristics				•		
Input Capacitance	C _{lss}			11000		PF
Output Capacitance	Coss	V _{DS} =25V,V _{GS} =0V,		914		PF
Reverse Transfer Capacitance	Crss	F=1.0MHz		695		PF
Switching Characteristics			•			
Turn-on Delay Time	t _{d(on)}			23		nS
Turn-on Rise Time	tr	V _{DD} =30V,I _D =2A,R _L =15Ω		190		nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =2.5Ω		130		nS
Turn-Off Fall Time	t _f			120		nS
Total Gate Charge	Qg		-	250		nC
Gate-Source Charge	Q _{gs}	ID=30A,VDD=30V,VGS=10V	-	48		nC
Gate-Drain Charge	Q _{gd}		-	98		nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =40A			1.2	V
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 40A		48		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs(Note2)		78		nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

- **1.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **2.** Pulse Test: Pulse Width \leq 400µs, Duty Cycle \leq 2%.
- **3.** EAS condition: Tj=25 $^\circ C$,V_DD=37.5V,V_G=10V,L=0.5mH,Rg=25\Omega,I_{AS}=37A



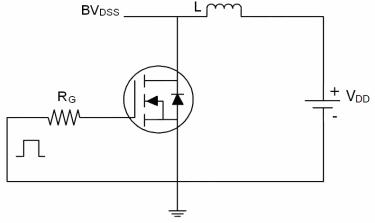
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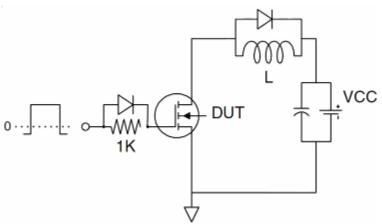


Test circuit

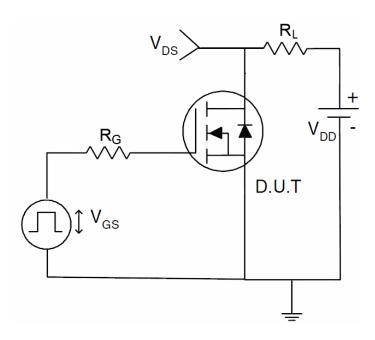
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit

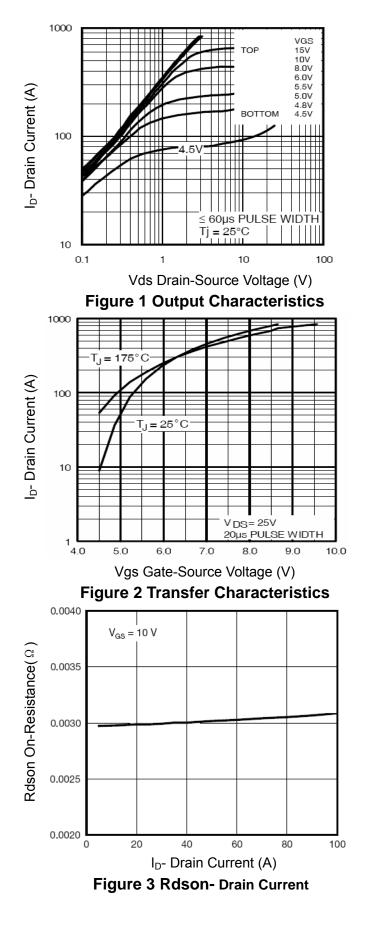


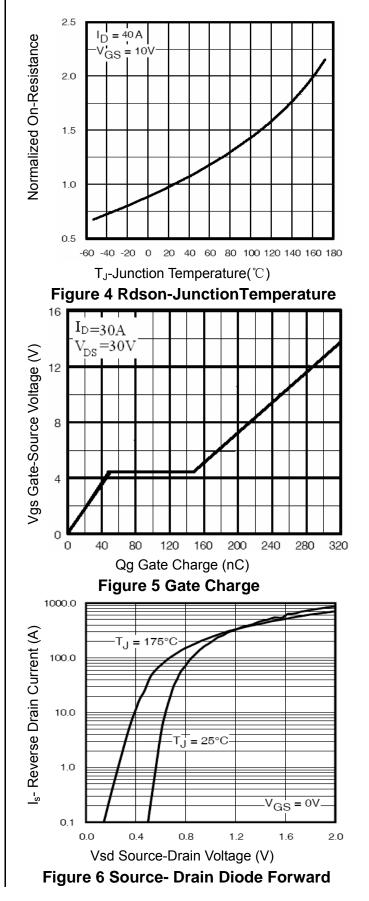






Typical Electrical and Thermal Characteristics

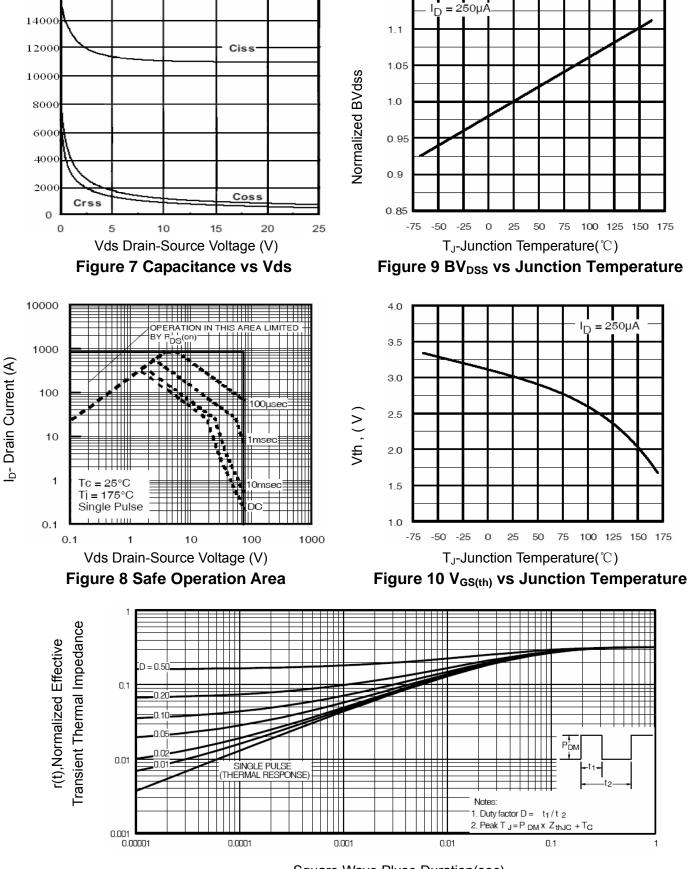




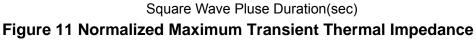


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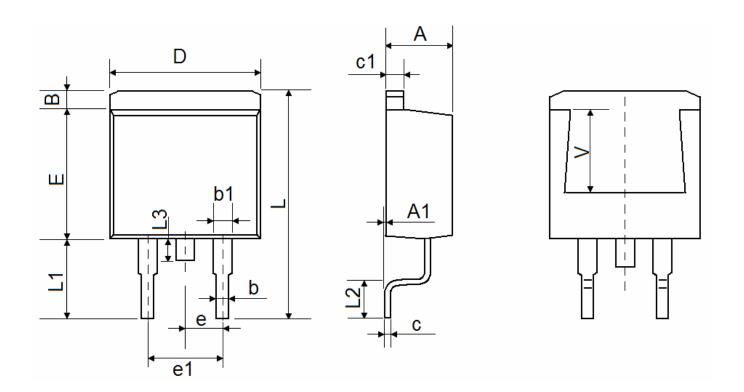
Pb Free Product

NCE75H21D





TO-263-2L Package Information



Symbol	Dimensions	s In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.170	1.370	0.046	0.054	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
с	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
L	15.050	15.450	0.593	0.608	
L1	5.080	5.480	0.200	0.216	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
V	5.60	00 REF	F 0.220 REF		







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